

TSER9615 适用于高速、高分辨率摄像头、雷达和其他传感器、具有 MIPI CSI-2 接口的 V³Link™ 7.55Gbps 串行器

1 特性

- 7.55Gbps (6Gbps 视频有效载荷) 串行器支持高速传感器, 包括 8MP+ 成像仪
- 支持 3 种数据速率: 7.55Gbps、3.775Gbps 和 1.8875Gbps。
- 同轴电缆供电 (PoC) 兼容收发器
- 具有 4 个通道的单个 MIPI D-PHY 端口
 - 符合 MIPI D-PHY v2.1 标准
 - 1 个时钟通道和 1、2 或 4 个可配置数据通道
 - 每通道速率高达 1.5Gbps
 - 支持极性引脚反转 (p/n)
 - 多达 16 个虚拟通道
- 单端口 MIPI CSI-2 接收器
 - 符合 MIPI CSI-2 v2.1 标准
 - 支持多种数据类型和多次曝光
- 高级数据保护和诊断, 包括 CRC 数据保护、传感器数据完整性检查、I²C 写保护、电压和温度测量、可编程警报以及线路故障检测
- 灵活的可编程输出时钟发生器
- 支持单端同轴电缆和屏蔽双绞线 (STP) 电缆
- 超低延迟双向 I2C 和 GPIO 控制通道支持从 ECU 进行 ISP 控制
- 单个 1.8V 电源
- 兼容所有 V³Link 视觉/增强视觉解串器
- 与 TSER953 串行器引脚对引脚兼容

2 应用

- 电器
- 视频监控
- 升降机和自动扶梯
- 工业机器人
- 机器视觉
- 患者监护和诊断
- 成像

3 说明

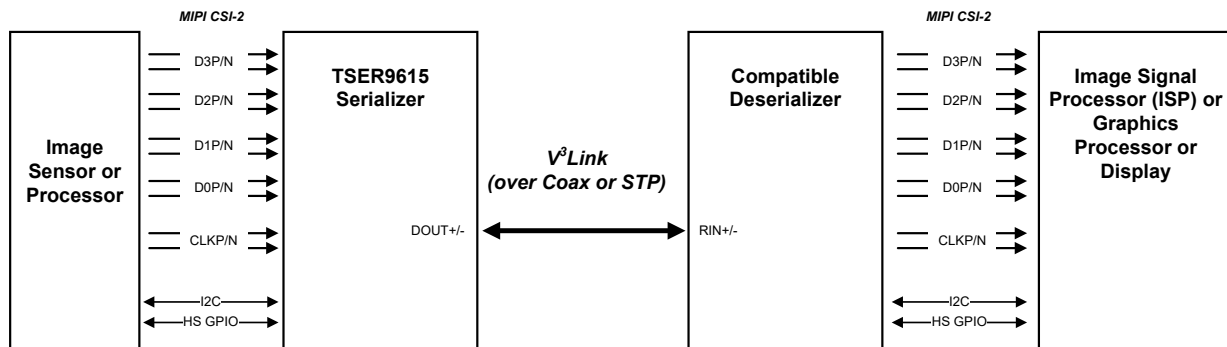
TSER9615 串行器属于 TI V³Link 增强视觉系列, 旨在支持 8MP+ 成像仪、卫星雷达、激光雷达和飞行时间 (ToF) 传感器等超高速数据传感器。该串行器提供 7.55Gbps 正向通道和超低延迟的 47.1875Mbps 双向控制通道, 并支持单根同轴 (PoC) 或 STP 电缆进行供电。当 TSER9615 在增强视觉模式下使用时, 可以在三种数据速率之间进行选择: 7.55Gbps、3.775Gbps 和 1.8875Gbps。TSER9615 具有先进的数据保护和诊断功能。在结合配套解串器的情况下, TSER9615 可提供精确的多摄像头传感器时钟和传感器同步。

TSER9615 具有 -20°C 至 85°C 的宽温度范围。该串行器采用小型 5mm × 5mm VQFN 封装, 适用于空间受限的传感器应用。

器件信息

器件型号	封装 (1)	封装尺寸 (标称值)
TSER9615	VQFN (32)	5.00mm × 5.00mm

(1) 要了解所有可用封装, 请见数据表末尾的可订购产品附录。



典型应用



4 Device and Documentation Support

4.1 接收文档更新通知

要接收文档更新通知，请导航至 ti.com 上的器件产品文件夹。点击 [通知](#) 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

4.2 支持资源

[TI E2E™ 中文支持论坛](#) 是工程师的重要参考资料，可直接从专家处获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题，获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的 [使用条款](#)。

4.3 Trademarks

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ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

4.5 术语表

TI 术语表

本术语表列出并解释了术语、首字母缩略词和定义。

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TSER9615RHBR	Active	Production	VQFN (RHB) 32	3000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-20 to 85	T9615
TSER9615RHBR.A	Active	Production	VQFN (RHB) 32	3000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-20 to 85	T9615
TSER9615RHBT	Active	Production	VQFN (RHB) 32	250 SMALL T&R	Yes	NIPDAU	Level-3-260C-168 HR	-20 to 85	T9615
TSER9615RHBT.A	Active	Production	VQFN (RHB) 32	250 SMALL T&R	Yes	NIPDAU	Level-3-260C-168 HR	-20 to 85	T9615

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

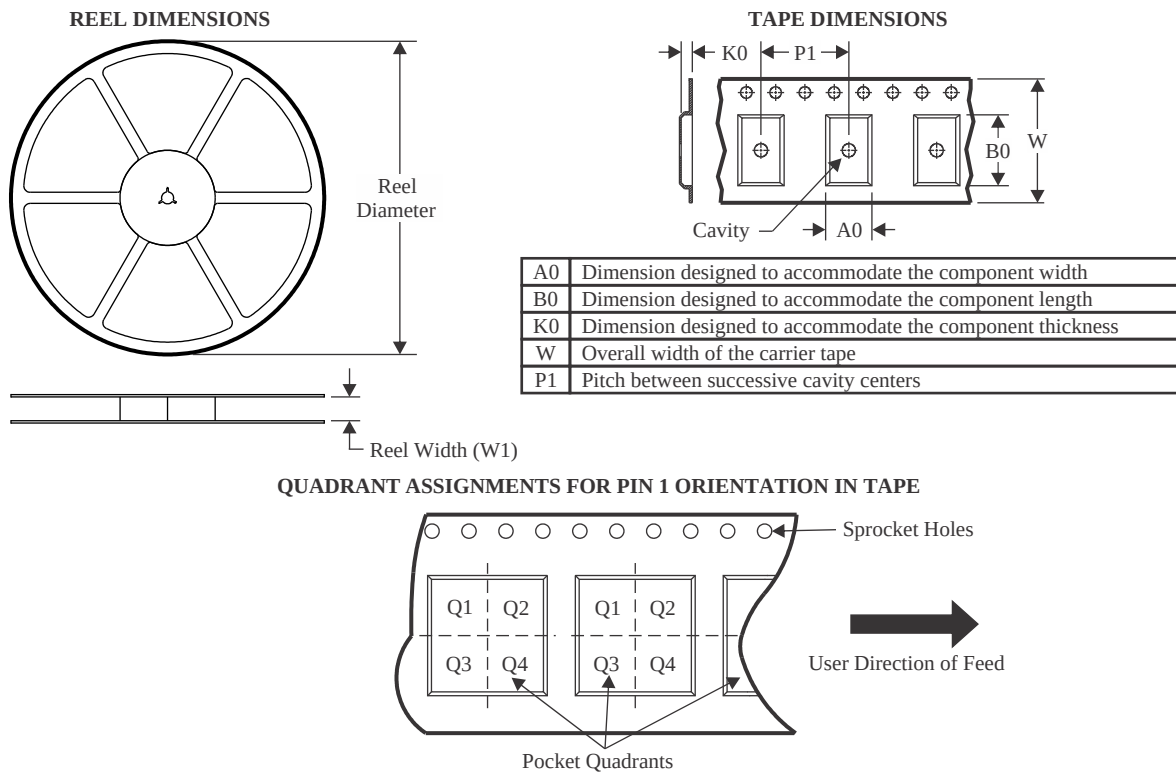
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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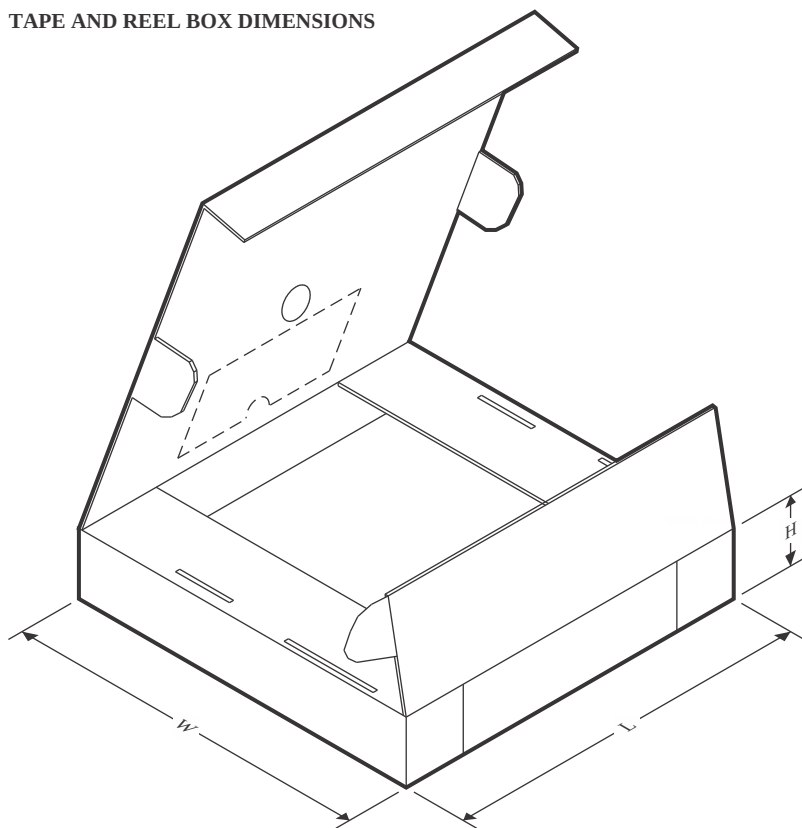
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TSER9615RHBR	VQFN	RHB	32	3000	330.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2
TSER9615RHBR	VQFN	RHB	32	3000	330.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2
TSER9615RHBT	VQFN	RHB	32	250	180.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2
TSER9615RHBT	VQFN	RHB	32	250	180.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TSER9615RHBR	VQFN	RHB	32	3000	360.0	360.0	36.0
TSER9615RHBR	VQFN	RHB	32	3000	346.0	346.0	33.0
TSER9615RHBT	VQFN	RHB	32	250	210.0	185.0	35.0
TSER9615RHBT	VQFN	RHB	32	250	210.0	185.0	35.0

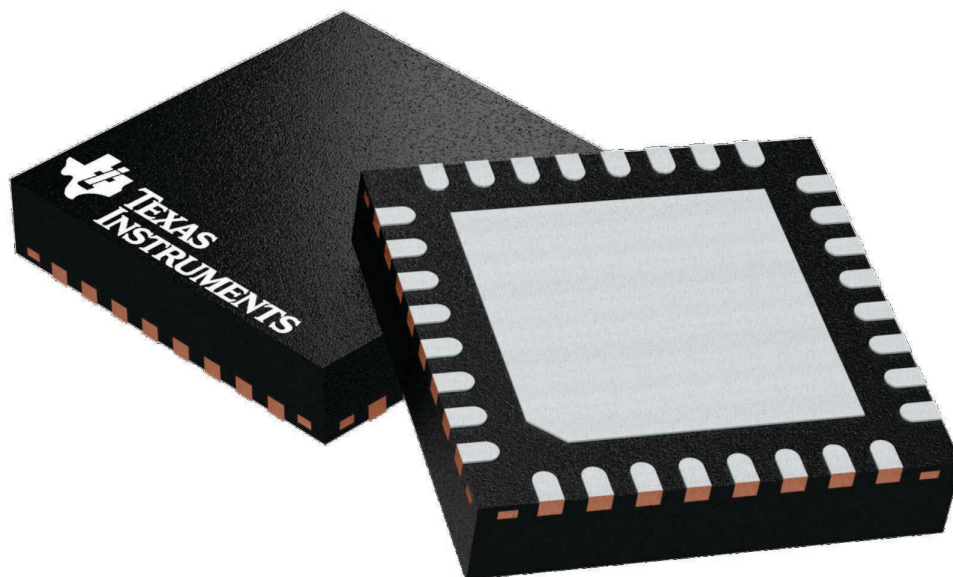
GENERIC PACKAGE VIEW

RHB 32

VQFN - 1 mm max height

5 x 5, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4224745/A



VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

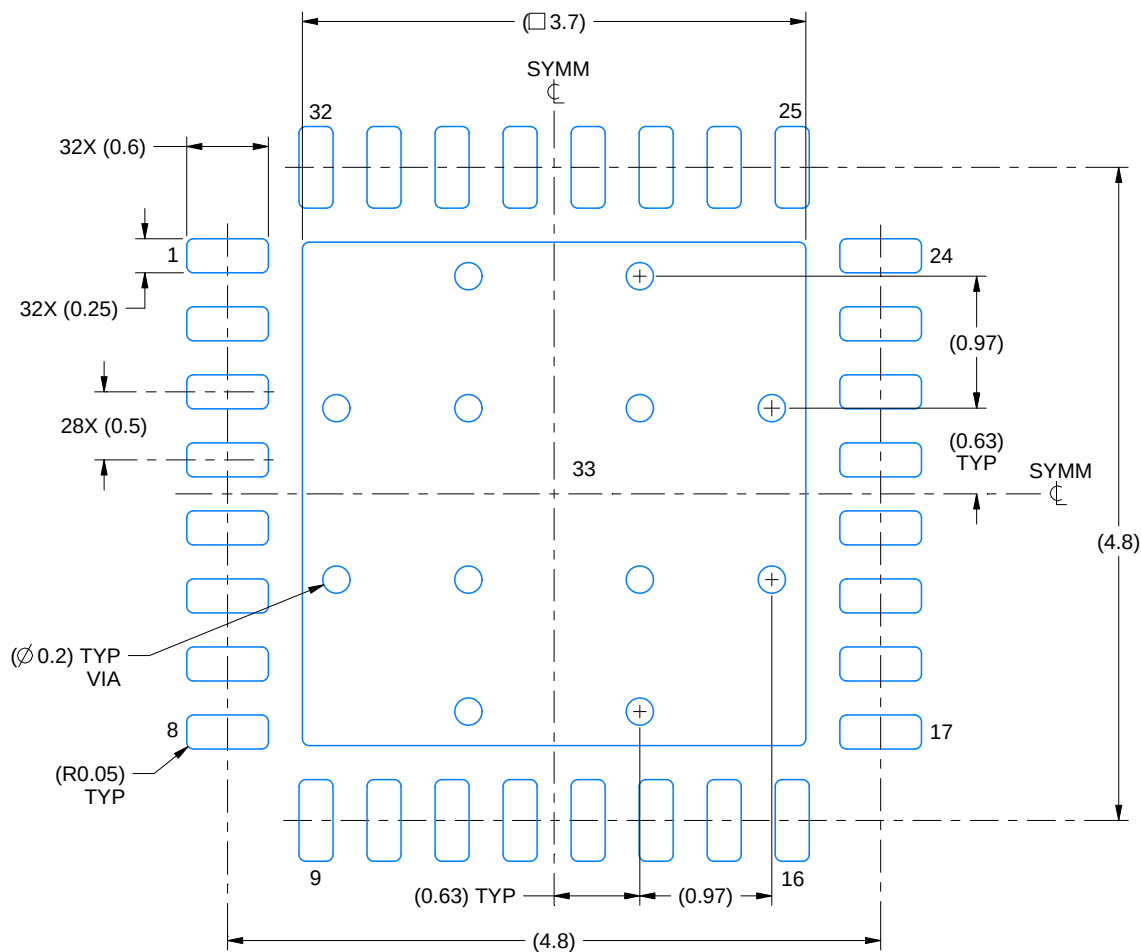


1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

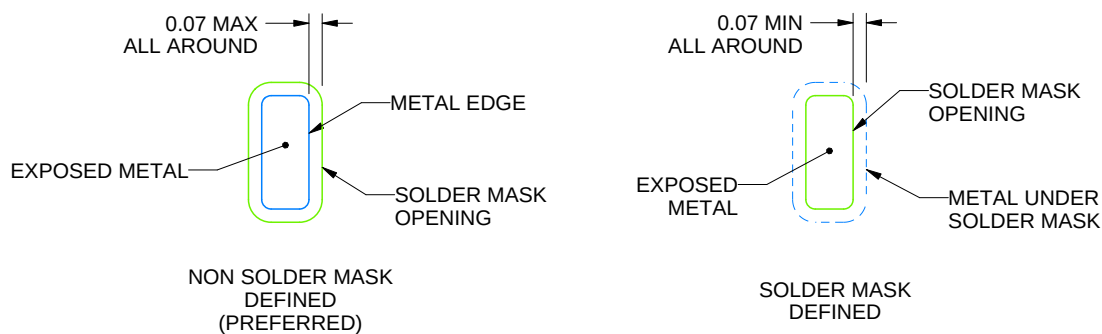
RHB0032U

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:18X



SOLDER MASK DETAILS

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NOTES: (continued)

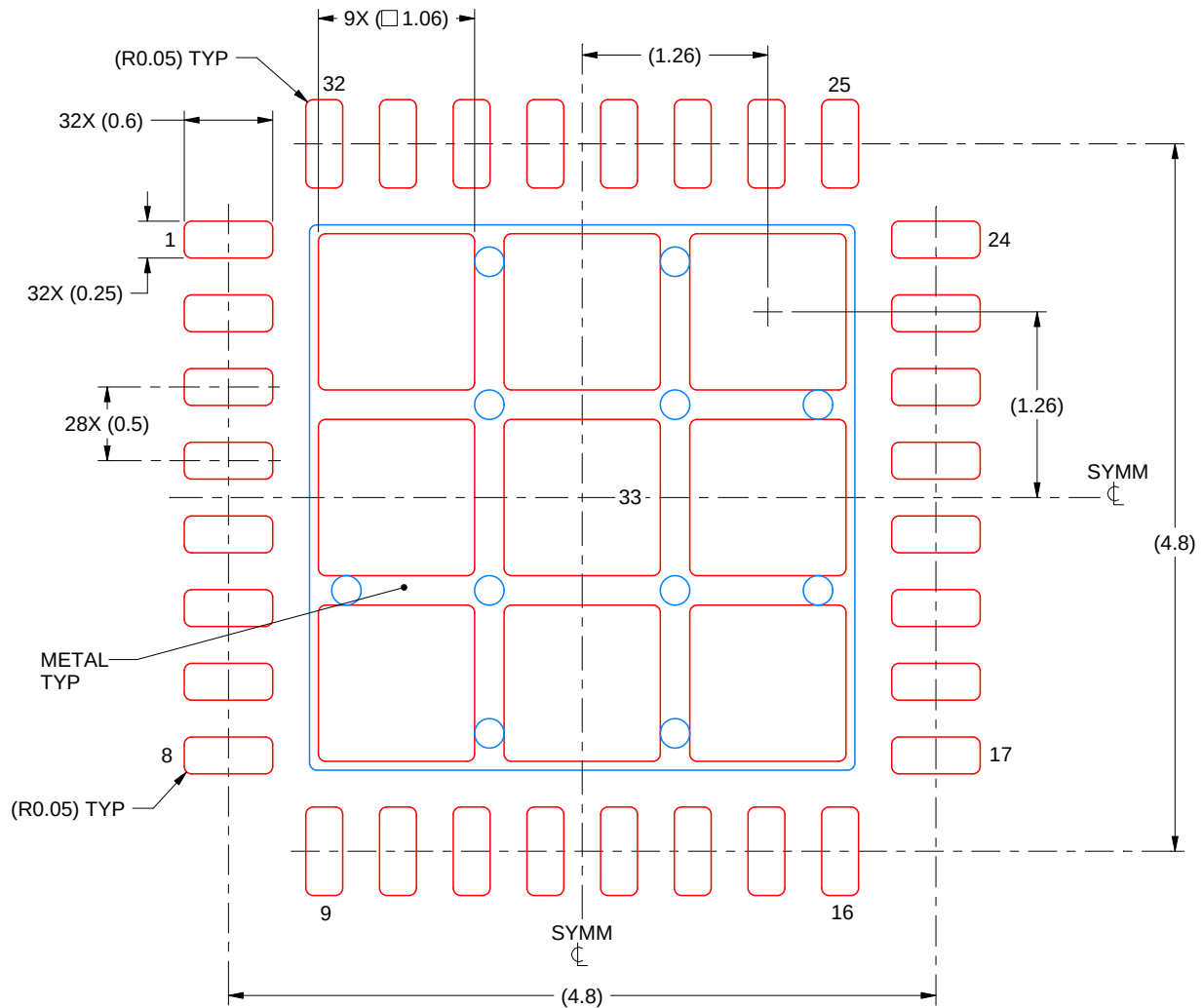
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

RHB0032U

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 33:
74% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
SCALE:20X

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NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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